1.0X0.5mm SMD CHIP LED LAMP

Part Number: KPHHS-1005SURCK  Hyper Red

Features
- 1.0mmX0.5mm SMT LED, 0.5mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description
The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions

Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.1(0.004") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.
### Selection Guide

<table>
<thead>
<tr>
<th>Part No.</th>
<th>Dice</th>
<th>Lens Type</th>
<th>(I_v) (mcd) [2] @ 20mA</th>
<th>Viewing Angle [1]</th>
</tr>
</thead>
<tbody>
<tr>
<td>KPHHS-1005SURCK</td>
<td>Hyper Red (AlGaInP)</td>
<td>Water Clear</td>
<td>Min. Typ. 281/2</td>
<td>120°</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>120 220</td>
<td>120°</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>*40 *70</td>
<td></td>
</tr>
</tbody>
</table>

**Notes:**
1. 81/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.
3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

### Electrical / Optical Characteristics at \(TA=25°C\)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Device</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Units</th>
<th>Test Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>(\lambda_{peak})</td>
<td>Peak Wavelength</td>
<td>Hyper Red</td>
<td>645</td>
<td>nm</td>
<td></td>
<td></td>
<td>(I=20)mA</td>
</tr>
<tr>
<td>(\lambda_{D}[1])</td>
<td>Dominant Wavelength</td>
<td>Hyper Red</td>
<td>630</td>
<td>nm</td>
<td></td>
<td></td>
<td>(I=20)mA</td>
</tr>
<tr>
<td>(\Delta\lambda/2)</td>
<td>Spectral Line Half-width</td>
<td>Hyper Red</td>
<td>28</td>
<td>nm</td>
<td></td>
<td></td>
<td>(I=20)mA</td>
</tr>
<tr>
<td>C</td>
<td>Capacitance</td>
<td>Hyper Red</td>
<td>35</td>
<td>pF</td>
<td></td>
<td></td>
<td>(V=0; f=1)MHz</td>
</tr>
<tr>
<td>(V_F[2])</td>
<td>Forward Voltage</td>
<td>Hyper Red</td>
<td>1.95</td>
<td>V</td>
<td>2.5</td>
<td></td>
<td>(I=20)mA</td>
</tr>
<tr>
<td>(I_R)</td>
<td>Reverse Current</td>
<td>Hyper Red</td>
<td>10</td>
<td>uA</td>
<td></td>
<td></td>
<td>(V=5)V</td>
</tr>
</tbody>
</table>

**Notes:**
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

### Absolute Maximum Ratings at \(TA=25°C\)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Hyper Red</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Power dissipation</td>
<td>75</td>
<td>mW</td>
</tr>
<tr>
<td>DC Forward Current</td>
<td>30</td>
<td>mA</td>
</tr>
<tr>
<td>Peak Forward Current [1]</td>
<td>185</td>
<td>mA</td>
</tr>
<tr>
<td>Reverse Voltage</td>
<td>5</td>
<td>V</td>
</tr>
<tr>
<td>Operating Temperature</td>
<td>-40°C To +85°C</td>
<td></td>
</tr>
<tr>
<td>Storage Temperature</td>
<td>-40°C To +85°C</td>
<td></td>
</tr>
</tbody>
</table>

**Note:**
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
Hyper Red KPHHS-1005SURCK

Relative Radiant Intensity

wavelength $\lambda$ (nm)

RELATIVE INTENSITY Vs. WAVELENGTH

$T_0=25^\circ C$

Forward Current (mA)

Forward Voltage (V)

FORWARD CURRENT Vs. FORWARD VOLTAGE

Luminous Intensity

Relative Value of $\phi_0$ (mW/mA)

LUMINOUS INTENSITY Vs. FORWARD CURRENT

Ambient Temperature $T_a$ (°C)

FORWARD CURRENT DERATING CURVE

Ambient Temperature $T_a$ (°C)

LUMINOUS INTENSITY Vs. AMBIENT TEMPERATURE

Spatial Distribution
KPHHS-1005SURCK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile for Lead-free SMT Process:

NOTES:
1. We recommend the reflow temperature 245°C (+/-3°C). The maximum soldering temperature should be limited to 260°C.
2. Do not excess stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern
(Units: mm; Tolerance: ± 0.1)

Reel Dimension

Tape Dimensions
(Units: mm)
Detailed application notes are listed on our website.
http://www.kingbright.com/application_notes